

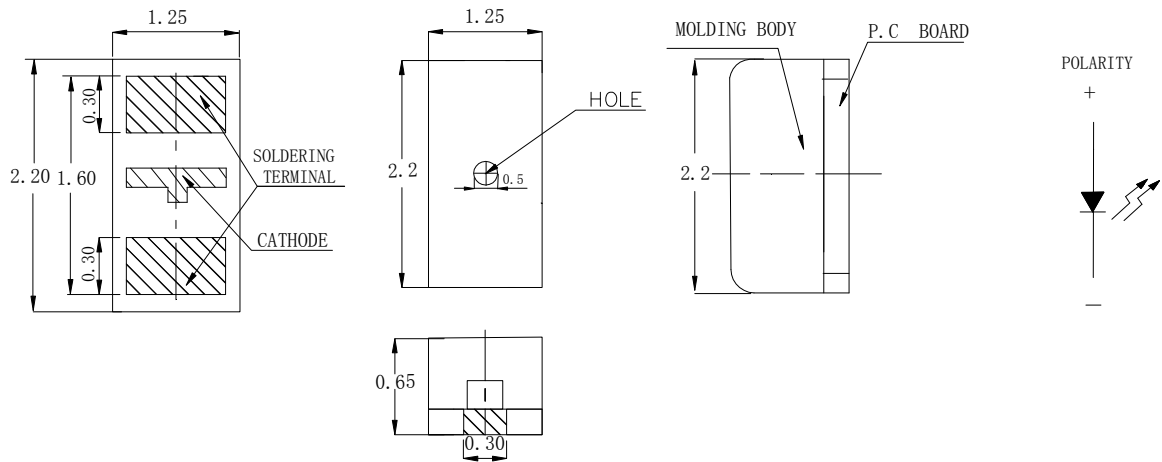
Features

- Low Power Consumption
- Various Colors
- Meet ROHS Green Product.

Applications

- Backlight and Indicator

Package Dimensions



Patent Protection

Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.2\text{mm}$ (.0079") unless otherwise noted.
3. Specifications are subject to change without notice
4. This drawing is only for reference, not as a basis for the actual structure.



Selection Guide

Part No	Lens Type	Dice	Emitted Color
FDC-22125065R-T5NRC	Water Clear	AllnGap	Red

Electrical / Optical Characteristics At Ta=25°C

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Condition
Iv	Luminous Intensity(Note 1)	11.2	28.0		mcd	IF=5mA
λ Peak	Peak Emission Wavelength		632		nm	IF=5mA
λ d	Dominant Wavelength		631		nm	IF=5mA
$\Delta\lambda$	Spectral Line Half-Width		20		nm	IF=5mA
VF	Forward Voltage	1.7	2.0	2.3	V	IF=5mA
IR	Reverse Current			10	μ A	VR 5V

Note:

1. The Luminous Intensity is measured with the led excluded the black lens cover.

Absolute Maximum Ratings At Ta=25°C

Parameter	Red	Unit
Power Dissipation	75	mW
Peak Forward Current[1]	80	mA
Continuous Forward Current	30	mA
Dreading Linear From25°C	0.4	mA/°C
Reverse Voltage	5	V
Electrostatic Discharge Threshold(HBM)	2000	V
Operating Temperature Range	-55°C to + 85°C	
Storage Temperature Range	-55°C to + 85°C	
Soldering Condition	260°C For 5 Seconds	

Note:

1. 1/10DutyCycle, 0.1msPulseWidth

Electrical Optical Characteristics Curves At Ta=25°C

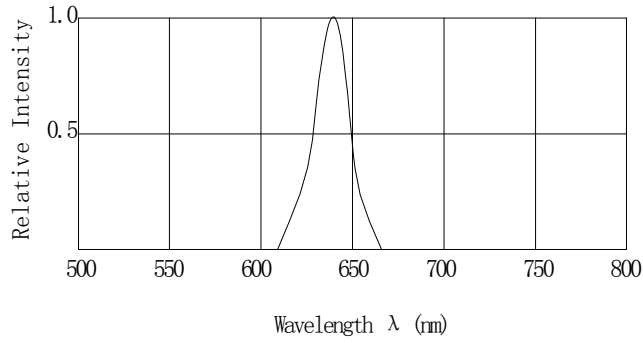


Fig. 1 Relative Intensity vs. Wavelength

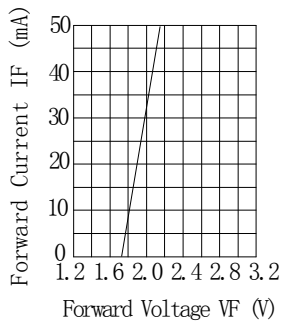


Fig. 2 Forward Current VS. Forward Voltage

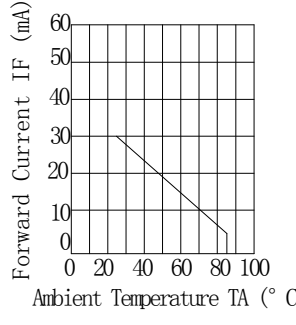


Fig. 3 Forward Current Derating Curve

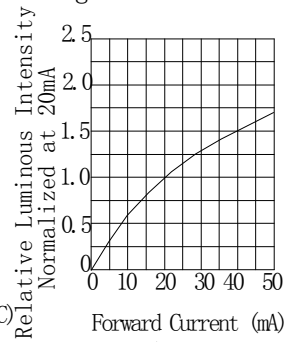


Fig. 4 Relative Luminous Intensity VS. Forward Current

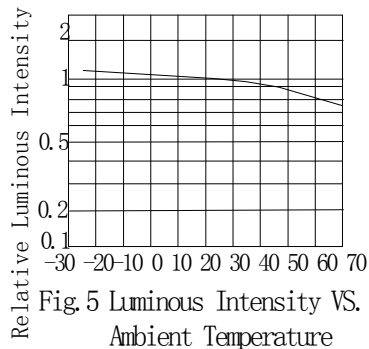
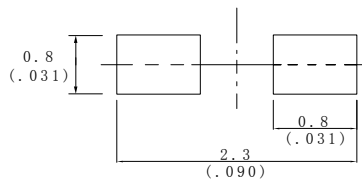


Fig. 5 Luminous Intensity VS. Ambient Temperature

Process Note

1. Sells gives no other assurances regarding the ability of to withstand ESD. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
2. Reflow soldering should not be done more than two times.
3. Do not stress LED when soldering, and do not warp the circuit board after soldering
4. While using Iron, Power dissipation of Iron should be smaller than 25W, and temperature should be controllable. The work should be finished within 2 sec under 320°C for once only.

Recommended Soldering Pad Dimensions**Notes:**

1. The LEDs should be used within a year.
2. The LEDs should be kept in 5~30°C and 60% RH for less.
3. The LEDs should be used within 24 hours, or else should be kept a 5~30°C and 30% RH or less. And LEDs should be used within 7 days after opening the package.

Reliability Test Items Conditions

Classification	Test Item	Test Conditions	Test hours	Result
Endurance Test	Opertion Life	Connect with a power $I_F=5mA$ T_a =Under room temperature	1000Hrs	0/20
	Hige Temperature High Humidity	$T_a=+65^{\circ}C\pm5^{\circ}C$ RH=90%-95%	240Hrs	0/20
	Hige Temperature Storage	High $T_a=+85^{\circ}C\pm5^{\circ}C$	1000Hrs	0/20
	Low Temperature Storage	Low $T_a=-35^{\circ}C\pm5^{\circ}C$ Test time=1000hrs	1000Hrs	0/20
Environmental Test	Temperature Cycling	$-45^{\circ}C\sim+105^{\circ}C$ 15min 5min 15min	300 Cycles	0/20
	Thermal Shock	$-35^{\circ}C\sim\pm5^{\circ}C\sim+85^{\circ}C\sim\pm5^{\circ}C$ 5min 10sec 5min	300 Cycles	0/20
	Solder Resistance	Preheating: $120^{\circ}C-150^{\circ}C$,within 2 minutes. Operation heating : $260^{\circ}C$ (Max.),within5 seconds(Max.)	5Cycles	0/20

Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Forward voltage	$V_F(V)$	$I_F=5mA$	Over $U\times 1.2$
Rvevrse current	$I_R(\mu A)$	$V_R=5V$	Over $U\times 2$
Luminous intensity	$I_v(mcd)$	$I_F=5mA$	Below $S\times 0.5$

Note: 1.U means the upper limit of specified characteristics. S means initial value.

2.Meansurment shall be taken between 2 hours after the test pieces have been returned to normal ambient conditions after completion of each test.